

04-11-2000

Docket No.: 98-1529 **09/485424**

FORM PTO-1595 (Modified)  
(Rev. 6-93)  
OMB No. 0651-0011 (exp. 4/94)  
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HEET

U.S. DEPARTMENT OF COMMERCE

Patent and Trademark Office

**6 Rec'd PCT/PTO**

**08 FEB 2000**

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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

**Hui Ye  
Christopher Stroch  
Tongsan Xiao  
Peter Strutt  
David E. Reisner**

Additional names(s) of conveying party(ies)  Yes  No

2. Name and address of receiving party(ies):

Name: US NANOCORP, INC.

Internal Address: \_\_\_\_\_

Street Address: 20 Washington Avenue

Suite 106

City: North Haven

State: CT

ZIP: 06473

3. Nature of conveyance:

Assignment

Merger

Security Agreement

Change of Name

Other \_\_\_\_\_

Execution Date: 6/3/99, 6/4/99 & 6/7/99

Additional name(s) & address(es) attached?  Yes  No

4. Application number(s) or registration numbers(s):

If this document is being filed together with a new application, the execution date of the application is: Even Date Herewith

A. Patent Application No.(s)

B. Patent No.(s)

**09/485424**

Additional numbers attached?  Yes  No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Leah M. Reimer

Internal Address: CANTOR COLBURN LLP

Street Address: 55 Griffin Road South

City: Bloomfield

State: CT

ZIP: 06002

6. Total number of applications and patents involved:

**1**

7. Total fee (37 CFR 3.41):.....\$ 40.00

Enclosed - Any excess or insufficiency should be credited or debited to deposit account

Authorized to be charged to deposit account

8. Deposit account number:

06-1130

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Leah M. Reimer

2/8/00

Name of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments, and document:

**3**

**PATENT**

REEL: 010666 FRAME: 0113

## ASSIGNMENT

WHEREAS We, Hui Ye, of Bloomington in the County of Hennepin and the State of Minnesota, Christopher Strock of Storrs in the County of Tolland and the State of Connecticut, Tongsan Xiao of Willington in the County of Tolland and the State of Connecticut, Peter Strutt of Storrs in the County of Tolland and the State of Connecticut and David Reisner of Bristol in the County of Hartford and the State of Connecticut; have invented certain new and useful improvements in:

ACTIVE MATERIAL FEEDS FOR THERMAL SPRAY SYSTEM'S  
METHOD OF MANUFACTURE, AND THERMAL SPRAYED  
ELECTRODES FOR ENERGY STORAGE AND CONVERSION DEVICES  
MADE THEREFROM

for which We have filed an application for Letters Patent of the United States;


AND WHEREAS, US Nanocorp, Inc., a corporation organized and existing under the laws of the State of Connecticut, having a place of business at 20 Washington Avenue, Suite 106, North Haven, CT 06473-2342, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

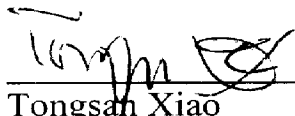
NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and sufficient consideration of one (\$1.00) dollar to me in hand paid, and other good and valuable considerations, the receipt of all of which is hereby acknowledged, We, the said Hui Ye, Christopher Strock, Tongsan Xiao, Peter Strutt and David Reisner; have sold, assigned, and transferred, and by these presents do sell, assign and transfer unto the said US Nanocorp, Inc., the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said US Nanocorp, Inc., an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of US Nanocorp, Inc. its successors and assigns; and We do hereby agree that the said US Nanocorp, Inc. may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign

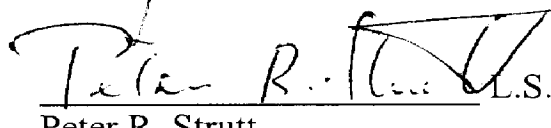
applications when called upon to do so by the said US Nanocorp, Inc. its successors or assigns, and that We will, at the cost and expense of the said US Nanocorp, Inc. fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declares that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: 6/7/99  L.S.  
Hui Ye

Date: 6/4/99  L.S.  
Christopher Strock

Date: 6/3/99  L.S.  
Tongsan Xiao

Date: 6/3/1999  L.S.  
Peter R. Strutt

Date: 6/4/99  L.S.  
David E. Reisner